SiHG21N65EF

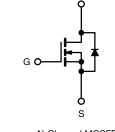


Vishay Siliconix

E Series Power MOSFET with Fast Body Diode

PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	700)
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.18
Q _g max. (nC)	106	3
Q _{gs} (nC)	14	
Q _{gd} (nC)	33	
Configuration	Sing	le





N-Channel MOSFET

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- · Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
- Battery chargers Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)
- · Applications using the following topologies
 - LCC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and Halogen-free	SiHG21N65EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	650	V
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T ₁ = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	L	21	
Continuous Drain Current $(1_j = 150 \text{ C})$	V _{GS} at 10 V	T _C = 100 °C	ID	13	А
Pulsed Drain Current ^a			I _{DM}	53	
Linear Derating Factor				1.7	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	367	mJ
Maximum Power Dissipation			PD	208	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope T _J = 125 °C		-l\//-lt	37)///	
Reverse Diode dV/dt ^d			dV/dt	31	V/ns
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 5.1 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

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THERMAL RESISTANCE RAT	INGS	1						
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		40			°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-		0.5		- °C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	50 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	_D = 1 mA	-	0.67	-	V/°(
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	2	-	4	V
Cata Sauraa Laakaga			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zara Cata Valtaga Drain Current		V _{DS} =	= 520 V, V _G	s = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 520 \	/, V _{GS} = 0 V	, T _J = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	١ _c	= 11 A	-	0.15	0.18	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D =	11 A	-	7.0	-	S
Dynamic	•	*						•
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$		-	2322	-		
Output Capacitance	C _{oss}		$V_{DS} = 100 $		-	105	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		-	4	-	1
Effective Output Capacitance, Energy Related ^a	C _{o(er)}		()		-	84	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{\rm DS} = 0.0$	/ to 520 V, V	/ _{GS} = 0 V	-	293	-	
Total Gate Charge	Qg				-	71	106	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 11 /	A, V _{DS} = 520 V	-	14	-	nC
Gate-Drain Charge	Q _{gd}				-	33	-	
Turn-On Delay Time	t _{d(on)}				-	22	44	
Rise Time	t _r	- V _{DD} =	= 520 V, I _D =	= 11 A,	-	34	68	
Turn-Off Delay Time	t _{d(off)}		= 10 V, R _g =		-	68	102	ns
Fall Time	t _f				-	42	84	
Gate Input Resistance	R _g	f = 1	MHz, open	drain	-	0.78	-	Ω
Drain-Source Body Diode Characterist		<u> </u>						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol		-	-	21	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	53	А
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 11 A	V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}				-	160	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	5 °C, I _F = I _S	= 11 A,	-	1.2	-	μ
Reverse Recovery Current	I _{RRM}	ai/dt =	100 A/µs, V	_R = 25 V	-	14	_	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. C_{oss(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

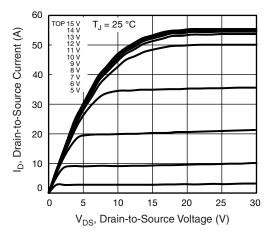


Fig. 1 - Typical Output Characteristics

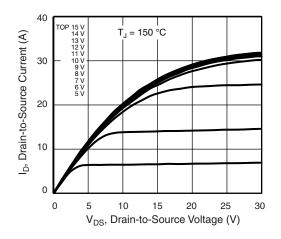


Fig. 2 - Typical Output Characteristics

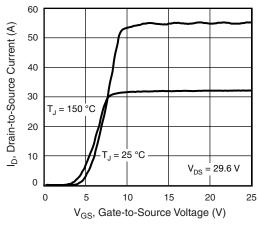


Fig. 3 - Typical Transfer Characteristics



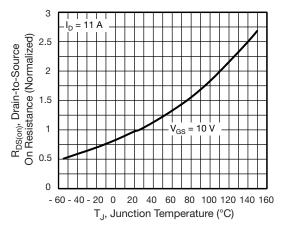


Fig. 4 - Normalized On-Resistance vs. Temperature

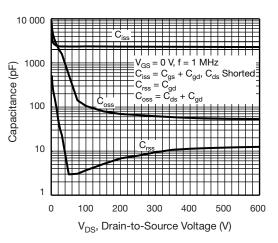


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

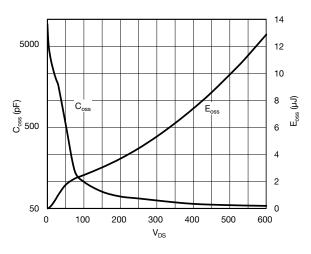


Fig. 6 - Coss and Eoss vs. VDS

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SiHG21N65EF

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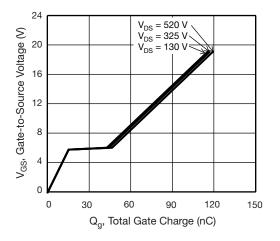


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

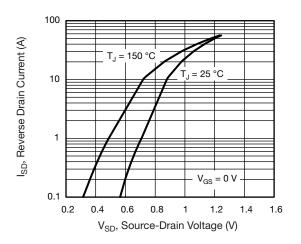


Fig. 8 - Typical Source-Drain Diode Forward Voltage

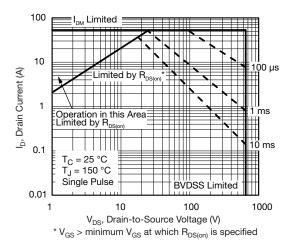


Fig. 9 - Maximum Safe Operating Area

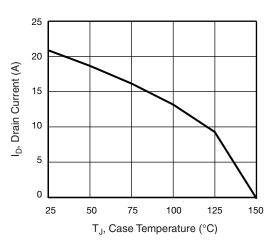


Fig. 10 - Maximum Drain Current vs. Case Temperature

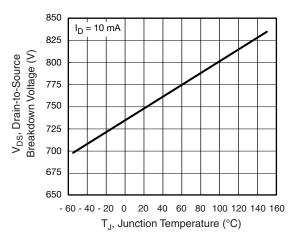


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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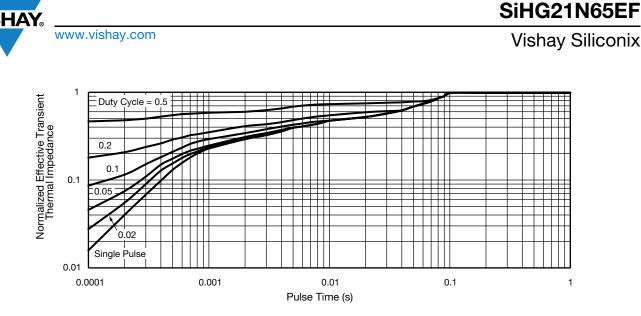


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

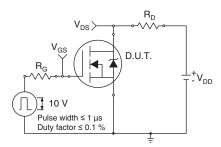


Fig. 13 - Switching Time Test Circuit

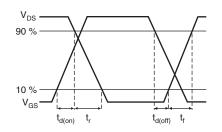


Fig. 14 - Switching Time Waveforms

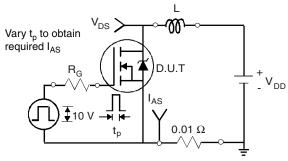


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

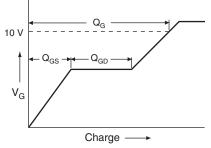


Fig. 17 - Basic Gate Charge Waveform

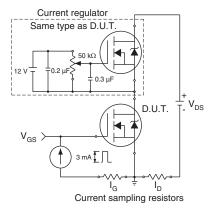


Fig. 18 - Gate Charge Test Circuit

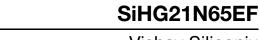
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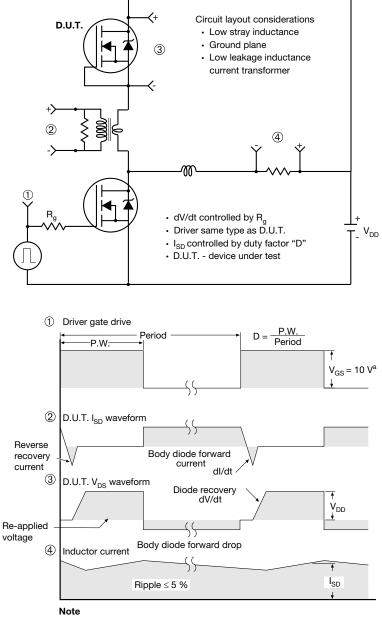
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-247AC (High Voltage)

VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØP	3.56	3.65	7
Ø P1	7.19) ref.	
Q	5.31	5.69	
S	5.54	5.74	

Notes

- ⁽¹⁾ Package reference: JEDEC[®] TO247, variation AC
- (2) All dimensions are in mm
- ⁽³⁾ Slot required, notch may be rounded
- ⁽⁴⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁵⁾ Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition

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VERSION 2: FACILITY CODE = Y



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
с	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
E	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØΡ	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51	BSC	

Notes

- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994
- ⁽²⁾ Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- ⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- ⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c



VERSION 3: FACILITY CODE = N



MILLIMETE	IETERS		MILLIMETERS		
DIM.	MIN.	MAX.	DIM.	MIN.	MAX.
А	4.65	5.31	D2	0.51	1.35
A1	2.21	2.59	E	15.29	15.87
A2	1.17	1.37	E1	13.46	-
b	0.99	1.40	е	5.46	BSC
b1	0.99	1.35	k	0.:	254
b2	1.65	2.39	L	14.20	16.10
b3	1.65	2.34	L1	3.71	4.29
b4	2.59	3.43	N	7.62	BSC
b5	2.59	3.38	Р	3.56	3.66
С	0.38	0.89	P1	-	7.39
c1	0.38	0.84	Q	5.31	5.69
D	19.71	20.70	R	4.52	5.49
D1	13.08	-	S	5.51	BSC

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

⁽²⁾ Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")



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